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original documents or copy thereof.

To the Honorable Commissioner of Patents ar.

1. Name of conveying party(ies):

Brian Meredith

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other

Execution Date: December 4, 1998

2. Name and address of receiving party(ies)

Name: Leaffield Engineering Limited

Internal Address:

Street Address: Leaffield Way, Leaffield

City: State: ZIP:

Corsham Wiltshire SN 139SS

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s)

29/095,878

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: David H. Jaffer

Internal Address: Rosenblum, Parish & Isaacs

Street Address: 160 W. Santa Clara Street,  
15th Floor

City: San Jose State: CA ZIP: 95113

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41).....\$ 40.00

☒ Enclosed

☐ Authorized to be charged to deposit account

8. Deposit account number:

08-0520

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David H. Jaffer

Name of Person Signing

Signature

3

Date

Total number of pages including cover sheet, attachments, and document:

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks, Box Assignments

Washington, D.C. 20231

PATENT

REEL: 9769 FRAME: 0176

**ASSIGNMENT**

I, Brian Meredith, a citizen of the United Kingdom for One Dollar (\$1.00) in hand paid to me, receipt of which is hereby acknowledged, and other good and valuable consideration, have assigned and do hereby assign to:

Leaffield Engineering Limited

a U.K. Corporation (hereinafter referred to as Assignee) its successors, assigns and legal representatives, the entire right, title and interest in and to all subject matter invented by Brian Meredith and disclosed and claimed in an application for Letters Patent of the United States of America, Serial No. 27/095,818 filed October 29, 1998, entitled:

**VALVE CAP ASSEMBLY**

and signed by me

☒ on the date set forth below;  
☐ on \_\_\_\_\_;

and in and to any and all divisions, reissues, continuations and extensions thereof; and in and to all corresponding applications for Letters Patent and all Convention and Treaty Rights of any kind, in all countries throughout the world, for all such subject matter.

I hereby authorize and request that the Patent Office Officials in the United States issue any and all of said Letters Patent or similar documents, when granted, to said Assignee, as the Assignee of our entire right, title and interest in and to the same, for the sole use and enjoyment of said Assignee, its successors and assigns.

Further, I agree that I will communicate to said Assignee, or its representatives, any facts known to me respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisions, continuations, substitutions, and renewal reexamination and reissue applications, execute all necessary Assignment papers to cause any and all of said Letters Patent to be issued to said Assignee, make all rightful oaths and generally do everything necessary or desirable to aid said Assignee, its successors and assigns, to obtain and enforce proper protection for said invention in the United States.

The undersigned hereby authorizes the firm of ROSENBLUM, PARISH & ISAACS to correct errors in this assignment or to insert any further identification or other information necessary or desirable to make this assignment suitable for recordal in the United States Patent Office.

In Testimony Whereof, I hereunto set my hand.

Brian Meredith

Inventor's Signature

Typed Name:

Brian Meredith

Address:

Leaffield Engineering Limited, Leaffield Way

Corsham Wiltshire SN 139SS

4/12/98

Date

4 DECEMBER 98